L Number	Hits	Search Text	DB	Time stamp
7	31	(covering with beak) and (field adjoxide)	USPAT; US-PGPUB	2004/08/31 08:59
8	589	(covering with (field adj oxide))	USPAT;	2004/08/31
9	580	((covering with (field adj oxide))) not ((covering with beak) and (field adj	US-PGPUB USPAT; US-PGPUB	09:00 2004/08/31 09:00
10	555	oxide)) (((covering with (field adj oxide))) not ((covering with beak) and (field adj	USPAT; US-PGPUB	2004/08/31
11	81	oxide))) and @ad<20020719 ((((covering with (field adj oxide))) not	USPAT;	2004/08/31
12	0	((covering with beak) and (field adj oxide))) and @ad<20020719) and clean\$3 (covering with STI) and MISFET	US-PGPUB USPAT;	09:55
13	0	(protecting with STI) and MISFET	US-PGPUB USPAT;	09:56 2004/08/31
14	1	(protect with STI) and MISFET	US-PGPUB USPAT;	09:56 2004/08/31
15	0	(protect with STI) and MISFET	US-PGPUB EPO; JPO;	09:57 2004/08/31
16	0	(protecting with STI) and MISFET	DERWENT; IBM_TDB EPO; JPO; DERWENT;	09:57 2004/08/31 09:58
17	0	(covering same STI) and MISFET	IBM_TDB EPO; JPO; DERWENT;	2004/08/31
18	0	(protecting same STI) and MISFET	IBM_TDB EPO; JPO; DERWENT;	2004/08/31 09:58
19	0	(protecting same STI) and MOSFET	IBM_TDB EPO; JPO; DERWENT;	2004/08/31 09:58
20	0	(covering same STI) and MOSFET	IBM_TDB EPO; JPO; DERWENT;	2004/08/31 09:59
21	44	(covering same STI) and MOSFET	IBM_TDB USPAT; US-PGPUB	2004/08/31
22	37	((covering same STI) and MOSFET) and @ad<20020719	USPAT; US-PGPUB	2004/08/31
23	71	MISFET and STI and @ad<20020719	USPAT; US-PGPUB	2004/08/31
24	14	(MISFET and STI and @ad<20020719) and cleaning	USPAT; US-PGPUB	2004/08/31
25	6	(MISFET and STI and @ad<20020719) and	USPAT;	2004/08/31
26	2	clean ((MISFET and STI and @ad<20020719) and clean) not ((MISFET and STI and	US-PGPUB USPAT; US-PGPUB	10:05 2004/08/31 10:13
27	69	<pre>@ad<20020719) and cleaning) (MISFET and STI and @ad<20020719) and etching</pre>	USPAT; US-PGPUB	2004/08/31
28	55	((MISFÉT and STI and @ad<20020719) and etching) not ((MISFET and STI and	USPAT; US-PGPUB	2004/08/31 10:06
29	5	<pre>@ad<20020719) and cleaning) ((((covering with (field adj oxide))) not ((covering with beak) and (field adj</pre>	USPAT; US-PGPUB	2004/08/31
30	57	oxide))) and @ad<20020719) and MISFET (MISFET and STI and @ad<20020719) not ((MISFET and STI and @ad<20020719) and	USPAT; US-PGPUB	2004/08/31
31	1	cleaning) MISFET and STI	EPO; JPO; DERWENT;	2004/08/31
32	0	MISFET and (FOX with STI) and	IBM_TDB USPAT;	2004/08/31
33	5	@ad<20020719 MISFET and ((field adj oxide) with STI)	US-PGPUB USPAT;	11:07
		and @ad<20020719	US-PGPUB	11:07

US-PAT-NO: 6411548

DOCUMENT-IDENTIFIER: US 6411548 B1

TITLE: Semiconductor memory having

transistors connected in

series

----- KWIC -----

Detailed Description Text - DETX (176):

First of all, as shown in FIG. 29, an n-type impurity is implanted into the

p-type silicon substrate 21 by the ion implantation method to form the n-type

well region 22. In addition, a p-type impurity is implanted into the n-type

well region 22 to form the p-type well region 23. Element isolation layers

linearly extending in the column direction are formed on the silicon substrate

21. The element isolation layers may be $\underline{\text{field oxide}}$ films formed by the LOCOS

method or layers having an <u>STI</u> (Shallow Trench Isolation) structure.